AMT2113 13.5 – 18GHz Power Amplifier Chip



Key Features:

Frequency: 13.5 – 18GHz
Typical small signal gain: 31dB
Typical output power: 43dBm

• Typical power added efficiency: 35%

Supply voltage: 28V, -1.8V

• Chip dimensions: 2.95mm x 2.35mm x 0.1mm

• Applications: wireless communication, transceiver module, radio telecommunication etc.

Description:

AMT2113 chip is a high performance high efficiency 13.5 – 18GHz power amplifier, it is designed based on Gallium Nitrate (GaN) HEMT process, with ground through metal via on the back technology. All chip products are 100% RF tested. AMT2113 is with dual voltage supply, drain voltage Vds at 28V, it provides 43dBm output power in 13.5 – 18GHz frequency range.

Absolute Maximum Ratings (Ta = 25°C)

| Symbol | Parameter | Value | Remark |
|--------|-----------------------|-------|--------------------------------|
| Vd | Drain Voltage | 35V | |
| Id | Drain Current | 4A | |
| Vg | Gate Voltage | -1.6V | |
| lg | Gate Current | 150mA | |
| Pd | DC Power Consumption | 100W | |
| Pin | Input Signal Power | 30dBm | |
| Tch | Operating Temperature | 150°C | |
| Tm | Sintering Temperature | 310°C | 30s, N ₂ protection |

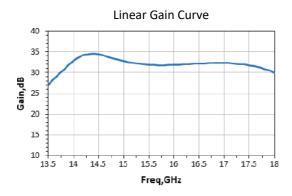
[1] Operation outside any of the Absolute Maximum Ratings may cause permanent device damage.

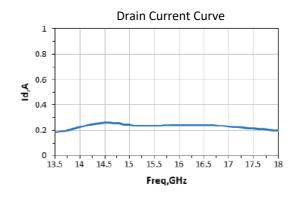
Electrical Characteristics (Ta = 25°C)

| Symbol | Parameter | Test Condition | Value | | Unit | |
|--------|------------------------|-----------------------|-------|---------|------|-----|
| | | | Min | Typical | Max | |
| Gain | Small Signal Gain | Vd = 28V | - | 31 | - | dB |
| VSWRin | Input SW | | - | 1.8 | 2 | dB |
| Pout | Saturated Output Power | Vg = -1.8V | - | 43 | - | dBm |
| PAE | Power Added Efficiency | F: 13.5~18GHz | - | 35 | - | % |
| Id | Operating Current | Duty Cycle : 10% | - | 2.3 | 2.5 | Α |

Note, under non-CW operation.

Typical Performance

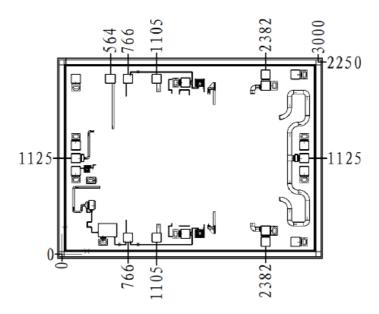




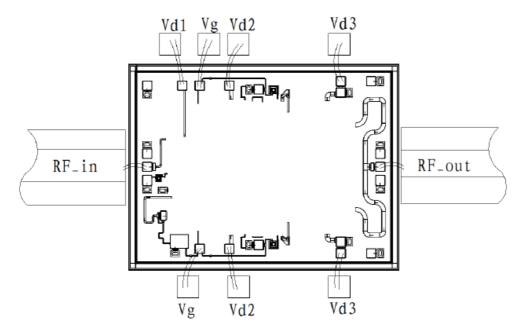




Chip Dimension (Unit: µm)



Chip Layout Diagram



Pad Definition

| Symbol | Function | Dimension | Equivalent Circuit |
|--------|---|------------|---------------------------|
| RF_in | RF signal input port, connecting to external 50Ω system. DC blocking capacitor is needed, if external DC current is applied to this pad. | 100*100μm² | RF_in O |
| RF_out | RF signal output port, connecting to external 50 $\!\Omega$ system, no need to add DC blocking capacitor. | 100*100μm² | RF_out |
| Vg | Amplifier gate bias, need external 100pF, 1000pF capacitor. | 100*100μm² | Vg V |
| Vd1 | Amplifier drain bias, need external 100pF, 1000pF capacitor. | 100*100μm² | Vd1 |
| Vd2 | Amplifier drain bias, need external 100pF, 1000pF capacitor. | 100*100μm² | Vd2 |
| Vd3 | Amplifier drain bias, need external 100pF, 1000pF capacitor. | 100*100μm² | Vd3 |

Refer to Appendix A for details.